

CYSH12AF InSb Hall Effect Element

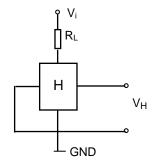
Hall-effect element CYSH12AF is made of compound semiconductor material indium stibnite (InSb), which utilizes the Hall-effect principle. It can convert a magnetic flux density signal linearly into voltage output. It is new generation of Hall Effect element CYTY101A.

FEATURES

- High Magnetic Sensitivity
- Low Offset Voltage
- Miniature Package

TYPICAL APPLICATION

- Magnetic Field Measurement
- Current Sensor
- Detection of Speed
- DC Brushless Motor
- Position Control



1. Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Rating	Unit
Maximum Input Current	Imax	20 (at 25°C)	mA
Maximum Power Dissipation	Pmax	150 (at 25°C)	mW
Operating Temperature Range	Тор	- 40 ~ + 120	°C
Storage Temperature Range	Tst	- 40 ~ + 150	°C

2. Electrical Characteristics (Measured at 25°C)

Parameter	Symbol	Measurement Conditions	Min	Max	Unit
Output Hall Voltage	VH	Vin = 1V, B = 50mT	196	320	mV
Input Resistance	Rin	I = 0.1mA	240	550	Ω
Output Resistance	Rout	I = 0.1mA	240	550	Ω
Offset Voltage	VO	Vin = 1V, B = 0G	- 7	+7	mV
Temp. Coeff. of VH	α	Ta = 0 ~ + 40°C AVG. B=50mT, Ic=5mA	-	- 1.8	% /°C
Temp. Coeff. of Rin, Rout	β	Ta = 0 ~ + 40°C AVG. B=0, Ic=0.1mA	-	- 1.8	% /°C

VH = VHM - VO (VHM : The output voltage measured at 500G.)

3. Rank Classification and Mark on Output Hall Voltage

Output Hall Voltage,VH (mV)	Rank	Mark	Measurement Conditions
196 ~ 236	D	SD	Vin=1V, B=50mT
228 ~ 274	E**	SE	(Constant Voltage)
266 ~ 320	F**	SF	(Constant Voltage)

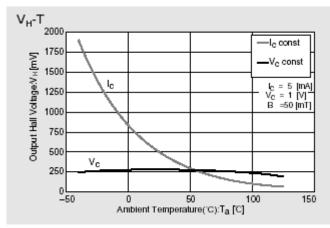
** As standard sensor we offer our customers the rank E and F

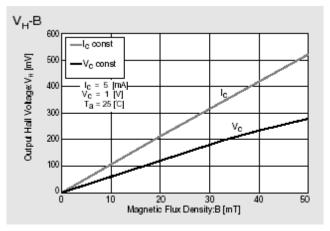
Tel.: +49 (0)8121 – 2574100 Fax: +49 (0)8121 – 2574101

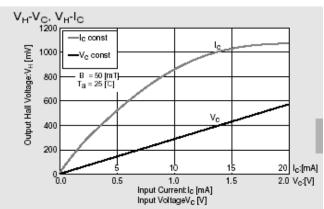
Email: info@cy-sensors.com http://www.cy-sensors.com

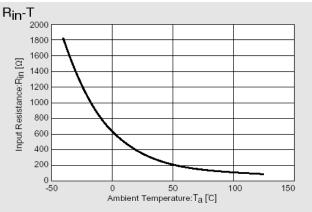


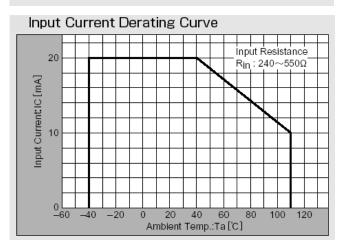
4. CHARACTERISTIC CURVES (only for references)

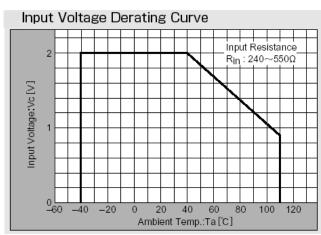












5. Method for Mounting

5-1. Soldering Conditions on PCB

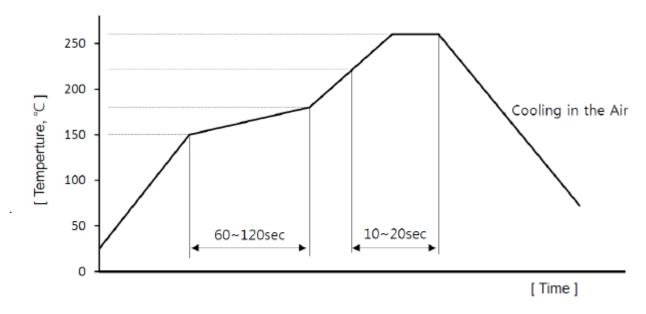
- 1. No Rapid Heating and Cooling.
- 2. Recommended Preheating condition is at 150~190°C for 2~3minutes.
- 3. Recommended Reflowing condition is at 220~230°C for 10~20seconds.

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5-2. Soldering Method and Temperature

Items	Methods	Temperature
Reflow	Soldering by Passing the Heated Zone	Max 260°C in 10sec
Solder Iron	Soldering by Soldering Iron	Max 350°C in 3sec

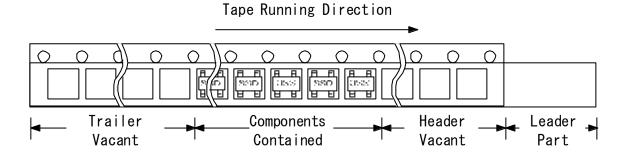


Reflow Method

6. Packaging

6-1. Taping

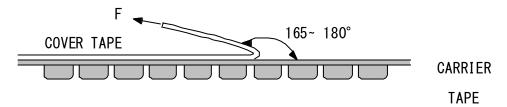
- 1. CYSH12AF should be packed that marked side is viewed from cover tape andlong side is put parallel with tape running direction. Making use of itafter 180° rotation has no problem because of its symmetric mode.
- 2. The vacant parts more than 40mm are located at front and end side of the reel.



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6-2. Tape Specifications

1. Pull Strength(F) = $20 \sim 70g$



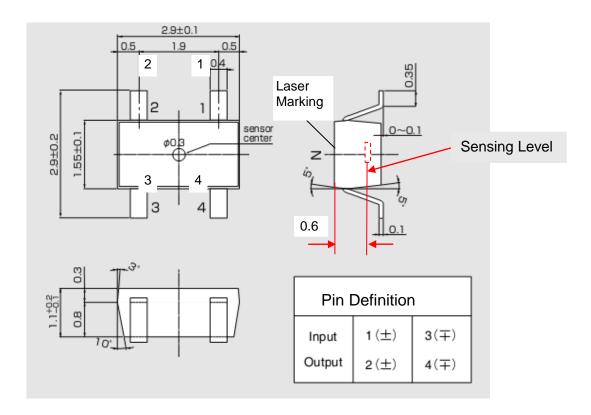
- 2. Devices should not be flipped out of a pocket when tape is bent down by 15mm curvature.
- 3. Devices should not be stuck to cover tape.
- 4. Devices should be kept below 40°C and below RH80% in the shade.
- 5. Tape has no joint.

6-3. Packing Unit

- 1. 3,000pcs of devices are packed in one reel.
- 2. Five reels are packed in one inner box.
- 3. Four inner boxes, 60,000pcs of devices, are packed in one outer box.
- 4. Dummy could be packed for safe dealing.

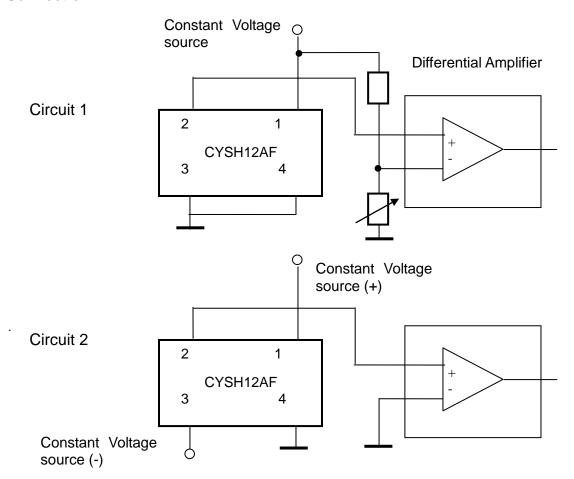
7. External Dimensions (Unit: mm)

Four leads of input and output terminals are designed in the diagonally symmetric mode and are equal in dimensions. Regardless of 180° rotation of Hall sensor, CYSH12AF can be used.





Connection



Application Notes

The Hall voltage V_H can be positive and negative. But if one connects the sensor as follows (circuit1):

Pin 1: positive input voltage V+, for instance +5VDC.

Pin 3: GND
Pin 2: OUTPUT
Pin 4: GND

One can only measure the positive voltage at the pin 2. This means that the output voltage at zero magnetic field is not zero. This voltage is called as offset voltage. The output voltage in this case is not equal to the Hall voltage. The output voltage is equal to the sum of offset voltage and Hall voltage.

The offset voltage will be zero if you connect double power supplies V+ and V- to the sensor (circuit 2):

Pin 1: positive input voltage V+, for instance +5VDC. Pin 3: negative input voltage V-, for instance -5VDC

Pin 2: OUTPUT Pin 4: GND

In this case the output voltage is equal to the Hall Voltage.



8. RELIABILITY

8. 1 TEST CONDITION

	CONDITION			
HIGH TEMP. STORAGE	Ta=150°C,t=1000HR			
LOW TEMP. STORAGE	Ta=-40°C,t=1000HR			
HIGH TEMP. OPERATION	Ta=120°C,lopr=10mA,t=1000HR			
LOW TEMP. OPERATION	Ta=-40°C,lopr=6mA,t=1000HR			
HIGH TEMP. HIGH UMIDITY OPERATION	Ta=85°C, HR=85%,lopr=9mA,t=1000HR			
HUMIDITY	Ta=60°C,HR=90%, t=1000HR			
PCT	Ta=121°C,HR=100%, Pv=2atm, t=24HR			
THERMAL SHOCK	T(L)=-55°C,T(H)=150°C, t=(L,H)=30min,M=30CYCLE			
SOLDERING HEAT	solder temp=260°C, t=10sec,REFLOW			
RESISTANCE				
SOLDABILITY	solder temp=230±5°C, t=5sec,dip			
TERMINAL STRENGTH	TENSION 300g/30sec			
ESD (MM)	V=500V, C=200pF, R=0Ω (test method EIAJ EDX 8503)			

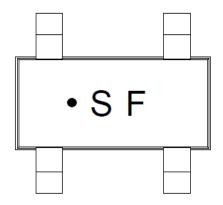
8.2 CRITERION FOR JUDGING

After each reliability test, samples should be kept for at least 24 hrs at room temp. & humidity, and then measured.

The change rates should be confined within the ranges as follows.

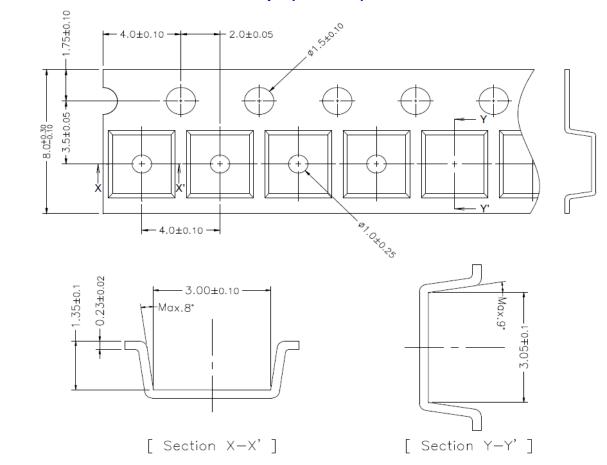
item	OK SPEC	NG/OK
ΔRin		
ΔRout	Under Initial ±20%	OK (SPEC SATISFYING)
ΔVΗ		
ΔVo/VH	Max. ± 5%	

9. Mark method

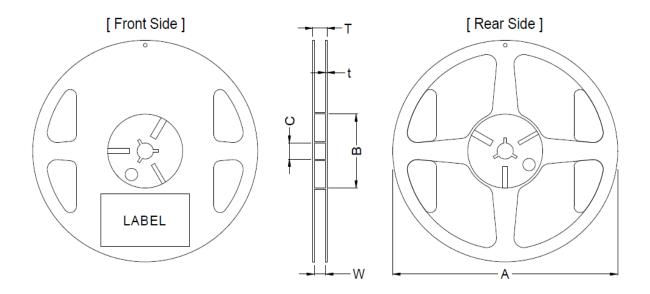




10. External Dimensions of Carrier Tape (Unit:mm)



11. External Dimensions of Reel (Unit: mm)



Symbol	Α	В	С	W	Т	t
Spec	Ø180 +0/-3	Ø60 +1/-0	Ø13±0.3	9±0.3	11.4±1.0	2.0 max

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